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# *New On-board Microprocessors*

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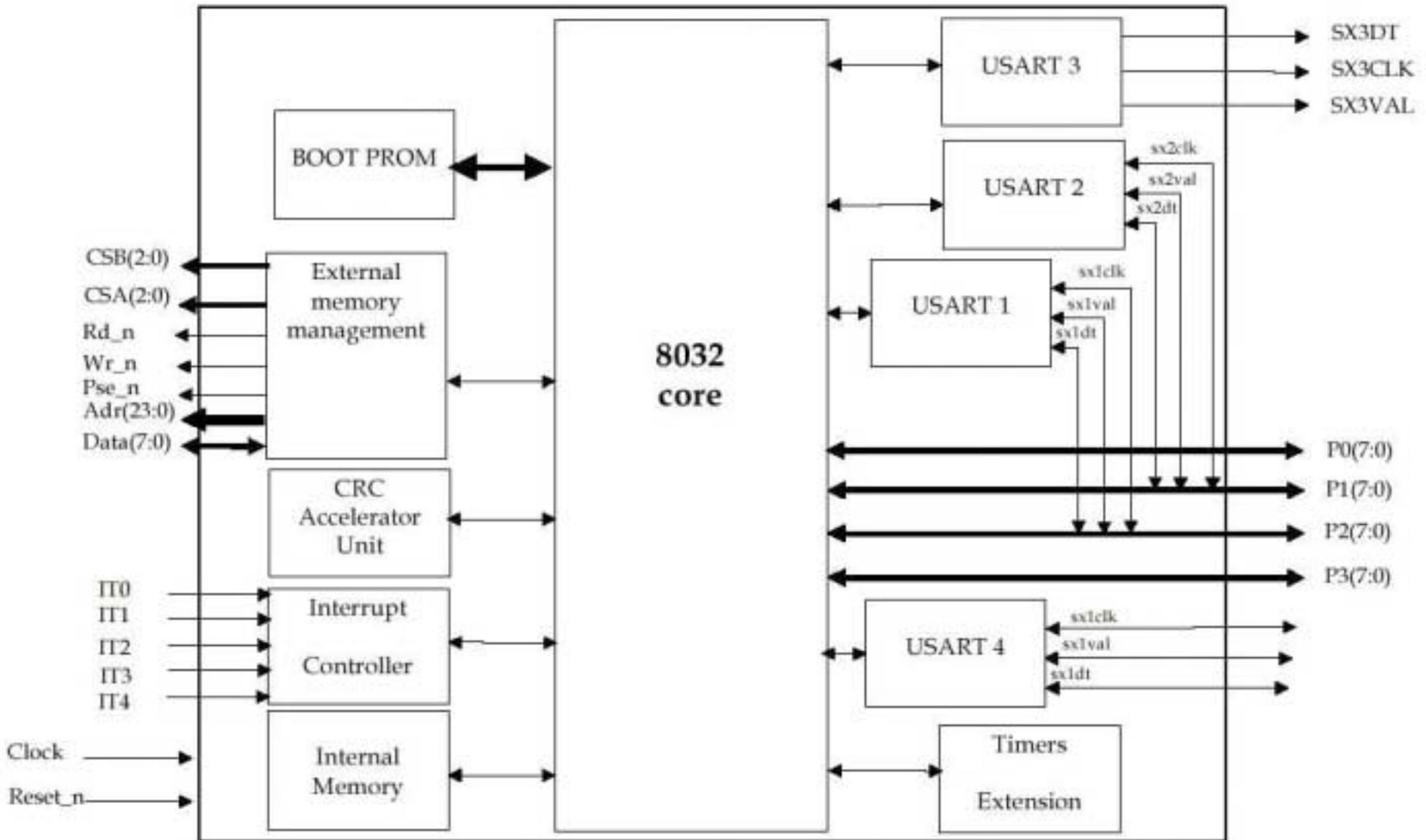
# The Microelectronics Section

- ◆ **Part of the Control and Data Division (TOS-ES) of ESTEC**
- ◆ **Microelectronics design, technology and methodology needed by control, data and signal processing systems for spacecraft platforms and payloads**
- ◆ **Specialist support in its domain of competence to ESA projects, to other sections/divisions in the department and to the European space industry**
- ◆ **Research in the area of microsystems and microelectronics with the particular goal of promoting the miniaturisation of spacecraft electronics**
- ◆ **Promoting techniques and methodologies for microelectronic design and development, in concert with the quality assurance department.**
- ◆ **Promoting the development and distribution of building blocks (IP-cores) for system-on-chip devices for the use in European space projects**
- ◆ **Promoting the development of standard components (ASIC, processors) for the use in European space projects**
  - 8-bit microcontroller: ADV80S32
  - 32-bit SPARC V8: LEON1

# 80S32 Microcontroller Overview

- ◆ **Fully compliant to the Intel 80x1 (8051...) architecture**
  - 8051 + additional standard peripherals = 8052
  - 8052 without program ROM = 8032
  - 8032 for space usage = 80S32
- ◆ **512 bytes on-chip RAM**
- ◆ **Bootstrap PROM for SW download via CCSDS TM/TC packets**
- ◆ **Memory interface for up to 16 Mbyte data and 8 Mbyte program**
- ◆ **3 counters with extended time count duration (16 bit @ CLK/12)**
- ◆ **4 USART supporting RS232, PacketWire and TTC-B-01**
- ◆ **5 external interrupts**
- ◆ **Hardware acceleration for CRC calculation**
- ◆ **Radiation tolerant technology**
  - 0.5  $\mu\text{m}$  ATMEL MG2RT: latchup and total dose (100 kRAD) immunity
  - SEU hardened flip-flops used for critical registers
  - Built-in 8+8-bit EDAC protection for internal and external memories

# 80S32 Architecture



# 80S32 Peripherals

- ◆ **1 Standard 80C52 UART (RS232)**
- ◆ **3 additional USART configurable in 3 operating modes:**
  - RS232 asynchronous (full duplex 8 bit words)
  - PacketWire synchronous (half duplex byte packets)
  - TTC-B-01 synchronous (half duplex 8 or 16 bit words)
  - Two 64 x 8-bit FIFO's for USART data buffering available
- ◆ **Interrupt controller for 15 interrupts, polled at each clock cycle**
  - 5 external interrupts
  - 3 timer interrupts
  - 5 USART interrupts
  - 2 interrupts for external and internal memory error
- ◆ **CRC accelerator unit for CCSDS Telecommand/Telemetry**
  - 16-bit CRC Calculation mapped to Special Function Registers
- ◆ **4 x 8-bit PIO (parallel input/output) ports**
  - Pins shared with alternate functions (RAM expansion, USART's, timers)

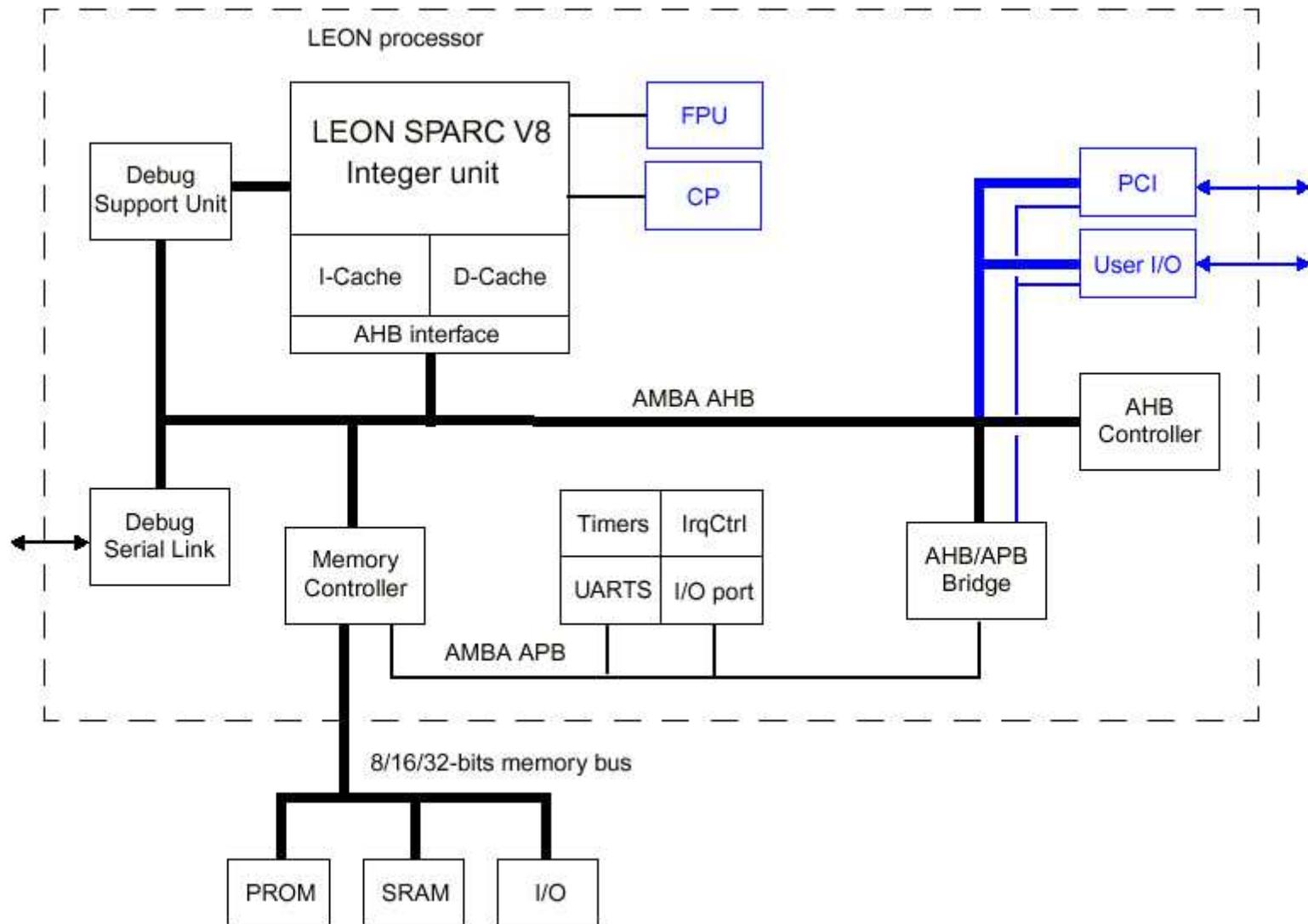
# 80S32 Summary

- ◆ **Package: MQFP 100 (100 pin, 20x20 mm)**
- ◆ **Supply Voltage 5V**
- ◆ **Max. clock frequency 20 MHz (estimate)**
- ◆ **Performance 3 MIPS @ 20 MHz**
- ◆ **Power consumption 235 mW @ 20 MHz**
- ◆ **Development Tools**
  - Keil
  - Dolphin
- ◆ **Availability**
  - Prototypes produced and tested in 2001
  - Datasheet available at ESA Microelectronics web site
  - Validation and production release outstanding
  - Distribution by Atmel and support by Transwitch (ADV)
- ◆ **Applications**
  - Controlling in instruments, antennae and sub-systems
  - Main processor on small satellites

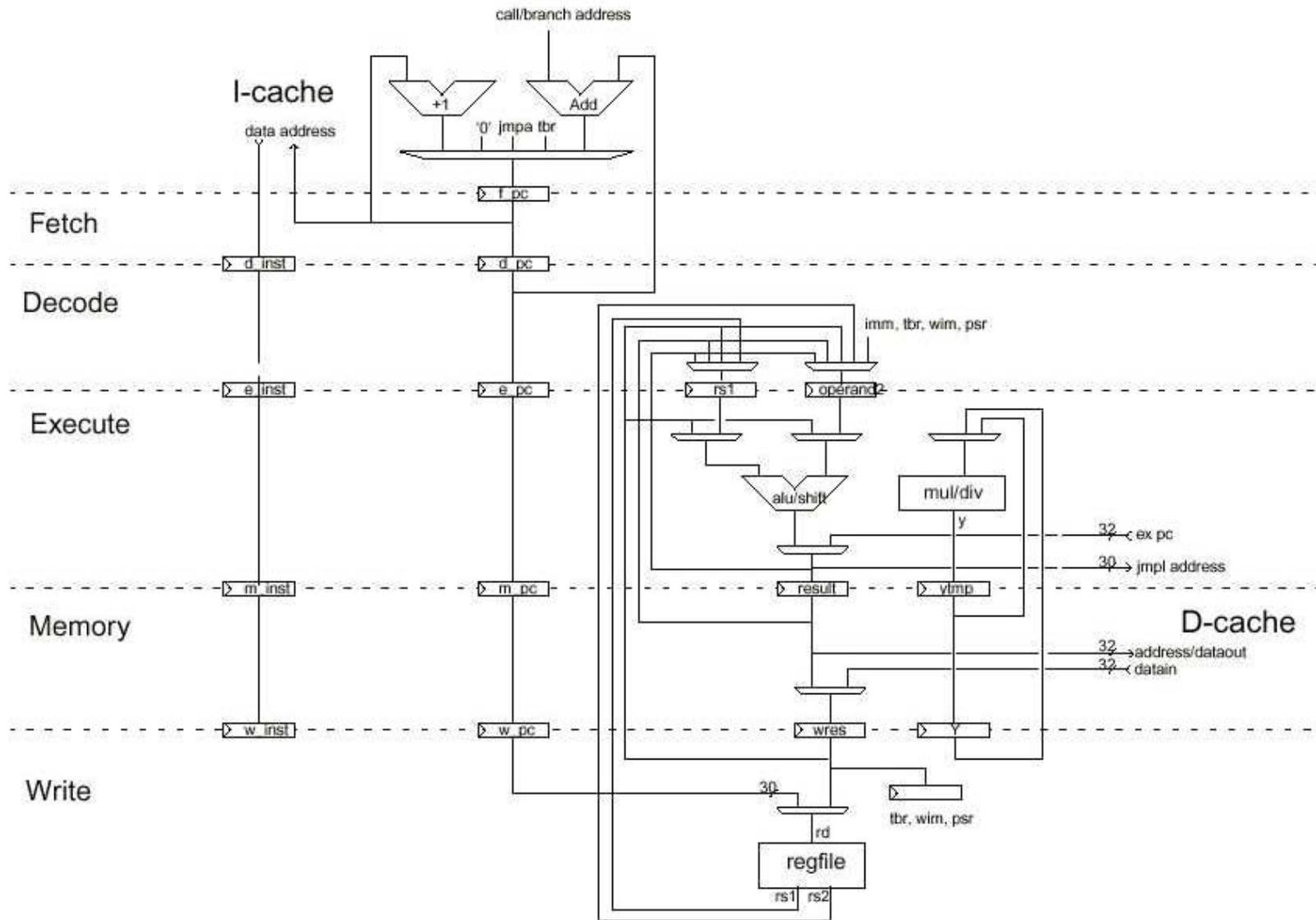
# LEON Processor Overview

- ◆ **LEON is a highly configurable VHDL model → System-On-Chip**
- ◆ **32-bit SPARC V8 Integer Unit, 5 pipeline stages, HW mul/div/mac**
- ◆ **Register Files supporting 2 – 32 register windows**
- ◆ **Harvard architecture: separate instruction/data caches (1-64 kByte)**
- ◆ **8/16/32 bit wide external SRAM (SDRAM planned)**
- ◆ **Hook-ups for coprocessor and/or FPU**
- ◆ **Standard peripherals: PIO, UART, Watchdog, Timers, Interrupts**
- ◆ **Hook-ups for other peripherals via the ARM - AMBA busses**
  - AHB for high speed, APB for low speed
- ◆ **Peripherals exist or are under development in form of IP-cores**
  - <http://www.estec.esa.int/microelectronics/core/corepage.html>
- ◆ **Debug support unit for on-chip debugging via a RS232 link**
  - Debugging after various HW and SW breakpoints and –conditions
  - Access to processor registers and instruction or AMBA bus transaction trace
- ◆ **Fault tolerance through EDAC and TMR flip-flops**
- ◆ **Performance ~ 1 dhrystone MIPS/MHz**

# LEON Architecture



# LEON Integer Unit

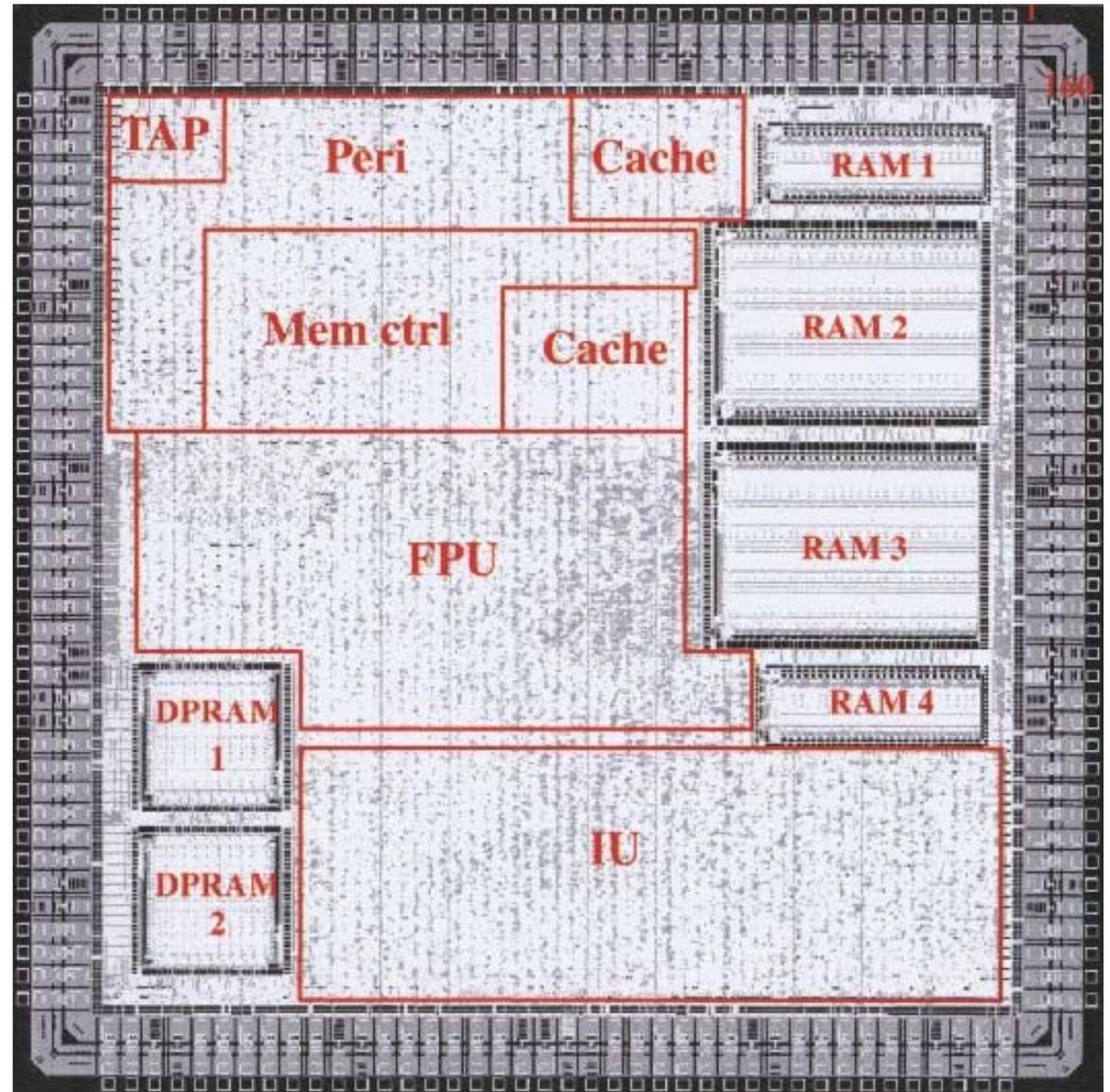


# LEON Implementations and Schedule

- ◆ **LEON1 Express: ES produced/tested on Atmel 0.35  $\mu\text{m}$  (2000/2001)**
- ◆ **Several FPGA implementations (Xilinx, Altera), ~ 25 MHz**
- ◆ **Commercial/University implementations on TSMC/UMC 0.18  $\mu\text{m}$**
- ◆ **LEON2 configuration:**
  - Advanced fault-tolerance achieved with EDAC and TMR
  - 2x8kByte data/instruction cache, 8 register windows
  - Meiko FPU (Sun Microsystems Communitysource)
  - 16x16 bit HW multiplier, HW divider (radix2)
  - MAC (16x16 bit to 40 bit accumulator)
  - 33 MHz 32 bit PCI master/target
  - Debug Support Unit (DSU)
- ◆ **LEON2 prototypes**
  - UMC 0.18  $\mu\text{m}$  commercial technology, 120 MHz (Q3/2002)
  - Atmel 0.25  $\mu\text{m}$  radiation hard process, 80-100 MHz (Mid/2003)
- ◆ **LEON2 production release in Atmel 0.25  $\mu\text{m}$  (Mid 2004)**
- ◆ **SW tools available from Gaisler Research:**
  - Simulator TSIM, LECCS: LEON/ERC32 cross-compiler system (GNU)

# LEON1 Express

- ◆ **Fault-tolerant version 2.1**
- ◆ **EDAC for memories**
- ◆ **TMR flip-flops**
- ◆ **Meiko FPU**
- ◆ **2\*4Kbyte caches**
- ◆ **Atmel ATC35 0.35  $\mu\text{m}$**
- ◆ **Latchup-free,**
- ◆ **Total-dose 300 Krad**
- ◆ **Total Area: 40 mm<sup>2</sup>**
- ◆ **Core 30 mm<sup>2</sup>, 70 kGates**
- ◆ **RAM blocks 10 mm<sup>2</sup>**
- ◆ **Pads 10 mm<sup>2</sup>**
- ◆ **Clock frequency 40 MHz**



# Links

- ◆ **ESA Microelectronics:** <http://www.estec.esa.int/microelectronics>
- ◆ **Transwitch:** <http://www.transwitch.com>
- ◆ **Keil Software:** <http://www.keil.com>
- ◆ **Dolphin Integration:** <http://www.dolphin.fr>
- ◆ **Gaisler Research:** <http://www.gaisler.com>
- ◆ **Atmel Wireless:** <http://www.atmel-wm.com>
- ◆ **LEON mailing lists:**
  - [http://www.yahoogle.com/group/leon\\_sparc](http://www.yahoogle.com/group/leon_sparc)
  - [http://www.yahoogle.com/group/leon\\_announce](http://www.yahoogle.com/group/leon_announce)
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